

Schichtaufbau im metallisierten Loch für EE-Kontakt Metal plating of plated-through hole for EE-contact

Durchmesser des metallisierten Loches

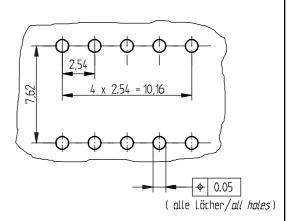
Diameter af finished plated-thraugh hale

Min. 0.1 Restringbreite

Restring width

Min. 25 µm Cu

Leiterplattenbohrbild *PCB drillhale pattern*



214781	M3
214782	M4
214780	6-32UNC
214779	8-32UNC
ldent-Nr. <i>Part Na</i> .	Gewinde <i>thread</i>

							, 0, , ,,0.	<i>''''</i> CGC	
protection memo from DIN 34	Information:	Tolerances	\Leftrightarrow	Scale	5:1				
		Al							
		Subject to modification without prior notice. Drawing will not be updated.		Designation	^{esignation} SVA 10-palig EE <i>Pawer Buq 10pin EE</i>				
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